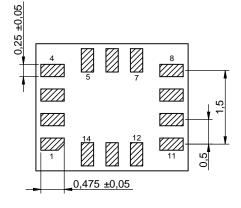
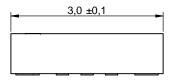
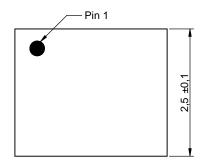
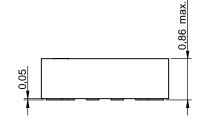
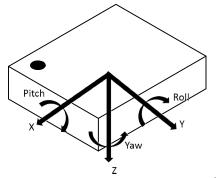
# **Dimensions: [mm]**





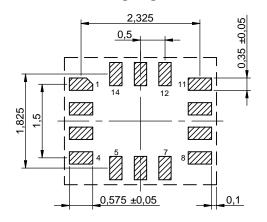






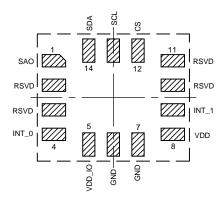
Scale - 13:1

# **Recommended Land Pattern: [mm]**



Scale - 13:1

# **Product Specific Pinning: (Top View)**



Scale - 13:1

		MiBo	001.002	DATE (YYYY-MM-DD) 2023-12-06	GENERAL TOLERANCE DIN ISO 2768-1m		PROJECTION METHOD	<b>-</b>
ROHS REACH COMPLIANT COMPLIANT			-ISDS IN	/IU 6 Axis S	Sensor			
WÜRTH ELEKTROI	EMC & Inductive Solutions Max-Eyth-Str. 1 7.4638 Waldenburg					253	6030320001	
MORE THA YOU EXPE	AIV Tel. +49 (0) 79 42 945 - 0				BUSINESS UNIT eiSos	status Valid		PAGE 1/9

# **Acceleration Sensor Specification:**

Properties		Test conditions		Value		<b>Unit</b> Hz  bits
Properties		rest conditions	min.	typ.	max.	UIIIL
Acceleration range	a <sub>RANGE</sub>	User selectable		±2/ ±4/ ±8/ ±16 g		
Number of measurement axis		X, Y, Z			3	
Output data rate	ODR	User selectable	1.6		6664	Hz
Resolution	RESa			16		bits
Sensitivity accuracy 1)	SEN <sub>a</sub>	T = 25 °C, aRANGE = ±2g	-3		3	%
Sensitivity change over temperature	SEN <sub>a_TC</sub>	delta from 25°C	-0.024	0.01	0.024	%/ °C
Noise density <sup>2)</sup>	n <sub>D</sub>	T = 25 °C, aRANGE = ±2g, High performance mode		75	170	μ <i>g /</i> √Hz
Og offset 3)	a <sub>OFF</sub>	T = 25 °C	-85 m <i>g</i>	±40 mg	+85 m <i>g</i>	
Offset change over temperature	a <sub>TCO</sub>			±0.1 mg/°C		
Nonlinearity	NL	aRange = ±8g; Best-fit straight line		±2 % <i>FS</i>		
Resonant frequency	f <sub>res_X</sub>	X		3		kHz
Resonant frequency	f <sub>res_Y</sub>	Υ		3		kHz
Resonant frequency	f <sub>res_Z</sub>	Z		2.2		kHz

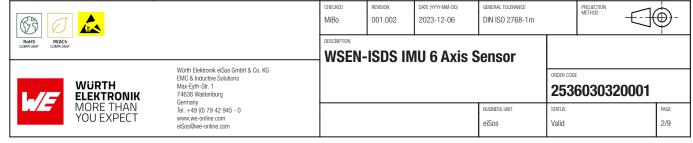
# **Gyroscope Sensor Specification:**

Duanautica		Toot conditions		Value		Unit
Properties		Test conditions	min.	typ.	max.	Unit
Number of measurement axis		X, Y, Z			3	
Gyroscope range	9 <sub>RANGE</sub>	User selectable		±125/±250/±500/±1000/±2000 dps		
Resolution	RES <sub>g</sub>			16		bits
Sensitivity accuracy 1)	SEN <sub>g</sub> - _ACC	T = 25°C, gRANGE = ±125dps	-3		3	%
Sensitivity change over temperature	SEN <sub>g</sub> . _TC	delta from 25°C	-0.048	0.007	0.048	%/°C
Noise density <sup>2)</sup>	n <sub>D</sub>	T = 25°C, high performance mode		3.8	11	mdps/ √Hz
Zero rate offset	g <sub>OFF</sub>	T = 25 °C		±2 dps		
Offset change over temperature	g <sub>TCO</sub>			±0.015 dps / °C		
Resonant frequency	f <sub>res</sub>	X,Y & Z axis		20		kHz

# **Temperature Sensor Specification:**

Properties			Value		Unit
rioperties		min.	typ.	max.	UIIIL
Measurement range	T <sub>RANGE</sub>	-40		85	°C
Sensitivity	SEN <sub>T</sub>		0.00390625 °C/digit		
Resolution	RES <sub>T</sub>		16		bits
Offset 1)	T <sub>OFF</sub>	-15		15	°C

<sup>1)</sup> Output of temperature sensor is 0 LSB typical at 25°C



Values are after factory calibration and trimming (parts are not soldered on PCB)
 The output values are independent of the selected output data rate
 Not measured during final test after production. These are charaterization values with limited number of samples

Values are after factory calibration and trimming (parts are not soldered on PCB)
 The output values are independent of the selected output data rate
 Not measured during final test after production. These are charaterization values with limited number of samples

# **Electrical Properties:**

Properties		Test conditions		Value		Unit
Properties		Test conditions	min.	typ.	max.	UIIIL
Operating supply voltage	$V_{DD}$		1.71	3.3	3.6	V
Operating supply voltage for I/O pins	V <sub>DD_IO</sub>		1.62		3.6	V
Current consumption in high performance mode	I <sub>DD_HP</sub>	ODR = 6.6kHz		694		μА
Current consumption in normal mode	I <sub>DD_NM</sub>	ODR = 104Hz		376		μА
Current consumption in low power mode	I <sub>DD_LP</sub>	ODR = 12.5Hz		280		μА
Current consumption in power down mode	I <sub>DD_PD</sub>			10		μА
Digital input voltage - high-level	V <sub>IH</sub>		0.7 * V <sub>DD_IO</sub>			
Digital input voltage - low-level	V <sub>IL</sub>				0.3 * V <sub>DD_IO</sub>	
Digital output voltage - high- level	V <sub>OH</sub>	$I_{OH} = 4 \text{ mA}$	V <sub>DD_IO</sub> - 0.2 V			
Digital output voltage - low-level	V <sub>OL</sub>	$I_{OL} = 4 \text{ mA}$			0.2 V	

# **Absolute Maximum Ratings:**

Properties		Va	lue	Unit
riopernes		min.	max.	UIIIL
Input voltage VDD pin	V <sub>DD</sub>	-0.3	4.8	V
Input voltage VDD_IO pin	V <sub>DD_IO</sub>	-0.3	4.8	V
Input voltage control pins 1)	V <sub>IN</sub>	-0.3 * V <sub>DD_I0</sub>	V <sub>DD_IO</sub> +0.3 V	
Maximum acceleration	a <sub>Max</sub>		10000	g

<sup>1)</sup> SDA, SCL, CS & SAO are control pins. Input voltage on any pin should never exceed 4.8 V.

# **General Information:**

Properties	Value	Unit
Operating Temperature	-40 up to +85 °C	
Storage Conditions (in original packaging)	< 40 °C; < 90 % RH	
Communication interface	I <sup>2</sup> C, SPI	
Moisture Sensitivity Level (MSL)	3	
Electrostatic discharge protection (HBM)	2	kV

# **Pin Description**

Pin	Pad	Description	1/0
SAO	1	I <sup>2</sup> C device address selection;SPI serial data output (MISO)	Input/Output
RSVD	2	Connect to VDD_IO (Optimize the power consumption during the device start-up sequence)	Input
RSVD	3	Connect to VDD_IO (Optimize the power consumption during the device start-up sequence)	Input
INT_0	4	Interrupt pin 0	Output
VDD_IO	5	Power supply voltage for I/O pins	Supply
GND	6	Negative supply voltage	Supply
GND	7	Negative supply voltage	Supply
VDD	8	Positive supply voltage	Supply
INT_1	9	Interrupt pin 1	Output
RSVD	10	Leave electrically unconnected and solder to the PCB	Input
RSVD	11	Connect to VDD_IO or Leave electrically unconnected and solder to the PCB	Input
CS	12	I <sup>2</sup> C enable/disable; SPI chip select	Input
SCL	13	I <sup>2</sup> C/SPI serial clock	Input

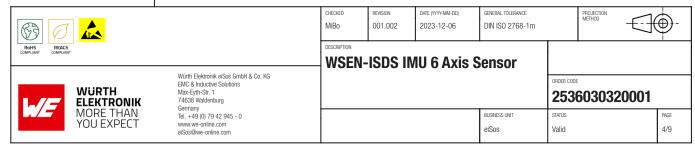
	RoHS REACH		MiBo	001.002	DATE (YYYY-MM-DD) 2023-12-06	GENERAL TOLERANCE DIN ISO 2768-1m		PROJECTION METHOD			
ROHS COMPLIANT COMPLIANT  Würth Elektronik eiSos GmbH & Co. KG		WSEN-	ISDS IN	/IU 6 Axis S	Sensor						
	<b>FRONIK</b>	Würth Elektronik eißos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg Germany					253	6030320001			
MURE	THAN EXPECT	Gentaly Tel. +49 (0) 79 42 945 - 0 www.we-online.com eiSos@we-online.com				BUSINESS UNIT eiSos	status Valid		PAGE 3/9		

# **Pin Description**

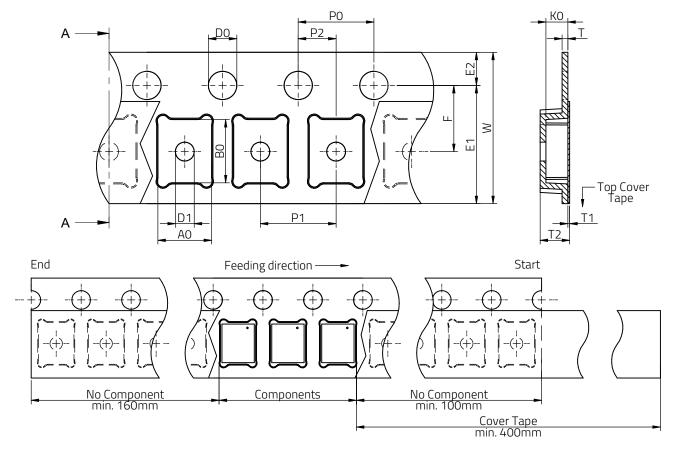
Pin	Pad	Description	1/0
SDA	14	I <sup>2</sup> C serial data; SPI serial data input (MOSI)	Input/Output

# **Certification:**

RoHS Approval	Compliant [2011/65/EU&2015/863]
REACh Approval	Conform or declared [(EC)1907/2006]



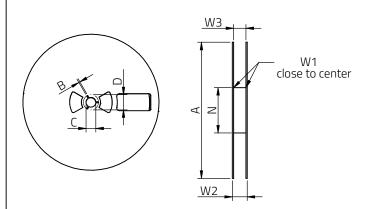
# Packaging Specification - Tape: [mm]

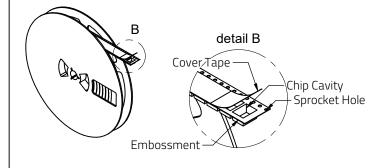


### Packaging is referred to the international standard IEC 60286-3:2019

	Tape Type	A0 (mm)	B0 (mm)	W (mm)	T (mm)	T1 (mm)	T2 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	DO (mm)	D1 (mm)	E1 (mm)	E2 (mm)	F (mm)	Material	Qty. (pcs.)
Tolerance		typ.	typ.	+0,3/ -0,1	ref.	ref.	typ.	typ.	±0,1	±0,1	±0,05	+0,1/-0,0	min.	±0,1	min.	±0,05		
Value	2a	2,84	3,35	8,00	0,30	0,10	1,36	1,16	4,00	4,00	2,00	1,50	0,30	1,75	6,25	3,50	Polystyrene	1000

# Packaging Specification - Reel: [mm]





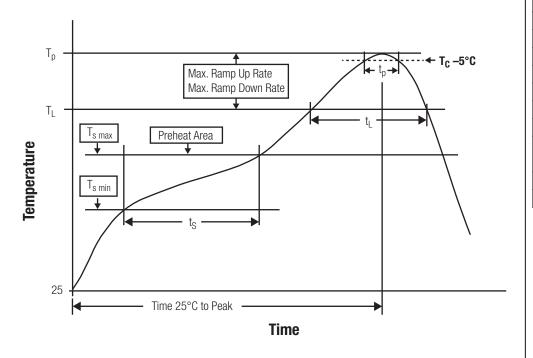
		A (mm)	B (mm)	C (mm)	D (mm)	N (mm)	W1 (mm)	W2 (mm)	W3 (mm)	W3 (mm)	Material
I	Tolerance	± 2,0	min.	min.	min.	min.	+1,5	max.	min.	max.	
ı	Value	178	1.5	12.8	20.2	50	8.4	14.4	7.9	10.9	Polystyrene

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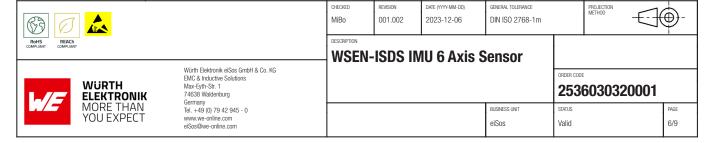
# **Classification Reflow Profile for SMT components:**



# **Classification Reflow Soldering Profile:**

Profile Feature		Value
Preheat Temperature Min	T <sub>s min</sub>	150 °C
Preheat Temperature Max	T <sub>s max</sub>	200 °C
Preheat Time $t_s$ from $T_{s min}$ to $T_{s max}$	t <sub>s</sub>	60 - 120 seconds
Ramp-up Rate (T <sub>L</sub> to T <sub>P</sub> )		3 °C/ second max.
Liquidous Temperature	T <sub>L</sub>	217 °C
Time t <sub>L</sub> maintained above T <sub>L</sub>	t <sub>L</sub>	60 - 150 seconds
Peak package body temperature	T <sub>p</sub>	260 °C
Time within 5°C of actual peak temperature	t <sub>p</sub>	20 - 30 seconds
Ramp-down Rate (T <sub>P</sub> to T <sub>L</sub> ) <sup>1)</sup>		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

<sup>1)</sup> In order to reduce residual stress on the sensor components, the recommended ramp-down temperature slope should not exceed 3°C/sec. refer to IPC/ JEDEC J-STD-020E



# Further information Component Libraries:



Download\_3D\_ISDS



Altium\_WSEN (V7.0)



Eagle\_WSEN (V7.0)



Download\_IGS\_ISDS



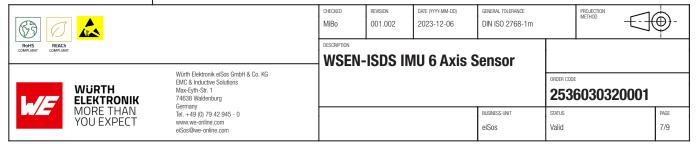
Download\_STP\_ISDS

### **Get a Quote:**

Request a quote here!

### **Tutorials:**

- MEMS Sensor Portfolio & Customer Service (PDF)
- Technical Support
- Wireless Connectivity & Sensors Overview



# **Cautions and Warnings:**

# The following conditions apply to all goods within the product series of sensor components of Würth Elektronik eiSos GmbH & Co. KG:

#### General:

- This electronic component is designed and manufactured for use in general electronic equipment.
- Würth Elektronik must be asked for written approval (following the PPAP procedure) before incorporating the components into any
  equipment in fields such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control,
  ship control), transportation signal, disaster prevention, medical, public information network, etc. where higher safety and reliability are
  especially required and/or if there is the possibility of direct damage or human injury.
- Electronic components that will be used in safety-critical or high-reliability applications, shall be pre-evaluated by the customer.
- The component is designed and manufactured to be used within the datasheet specified values. If the usage and operation conditions specified in the datasheet are not met, the wire insulation may be damaged or dissolved.
- Do not drop or impact the components, the component may be damaged
- Würth Elektronik products are qualified according to international standards, which are listed in each product reliability report. Würth
  Elektronik does not warrant any customer qualified product characteristics beyond Würth Elektroniks' specifications, for its validity and
  sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the authority of the customer. All technical specifications for standard products also apply to customer specific products.

### **Product specific:**

### Soldering:

- The solder profile must comply with the technical product specifications. All other profiles will void the warranty.
- · All other soldering methods are at the customers' own risk.

### **Cleaning and Washing:**

- Washing agents used during the production to clean the customer application might damage or change the characteristics of the component. Washing agents may have a negative effect on the long-term functionality of the product.
- Using a brush during the cleaning process may damage the component. Therefore, we do not recommend using a brush during the PCB cleaning process.

### **Potting and Coating:**

Potting material might shrink or expand during and after hardening. This might apply mechanical stress on the components, which can
influence the characteristics of the transfer function. In addition, potting material can close existing openings in the housing. This can
lead to a malfunction of the component. Thus, potting is not recommended.

Conformal coating may affect the product performance. We do not recommend coating the components.

### **Storage Conditions:**

- A storage of Würth Elektronik products for longer than 12 months is not recommended. Within other effects, the terminals may suffer
  degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of
  shipment.
- Do not expose the components to direct sunlight.
- The storage conditions in the original packaging are defined according to DIN EN 61760-2.
- For a moisture sensitive component, the storage condition in the original packaging is defined according to IPC/JEDEC-J-STD-033. It is
  also recommended to return the component to the original moisture proof bag and reseal the moisture proof bag again.
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components.

### **Packaging:**

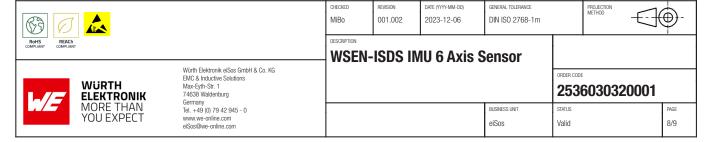
 The packaging specifications apply only to purchase orders comprising whole packaging units. If the ordered quantity exceeds or is lower than the specified packaging unit, packaging in accordance with the packaging specifications cannot be ensured.

### Handling:

- Violation of the technical product specifications such as exceeding the nominal rated supply voltage, will void the warranty.
- Violation of the technical product specifications such as but not limited to exceeding the absolute maximum ratings will void the conformance to regulatory requirements.
- ESD prevention methods need to be followed for manual handling and processing by machinery.
- The edge castellation is designed and made for prototyping, i.e. hand soldering purposes only.
- The applicable country regulations and specific environmental regulations must be observed.
- Do not disassemble the product. Evidence of tampering will void the warranty.
- The temperature rise of the component must be taken into consideration. The operating temperature is comprised of ambient temperature and temperature rise of the component. The operating temperature of the component shall not exceed the maximum temperature specified.

These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.

All topics are described in a more detailed manner in the user manual for each product.



# **Important Notes**

# The following conditions apply to all goods within the product range of Würth Elektronik eiSos GmbH & Co. KG:

### 1. General Customer Responsibility

Some goods within the product range of Würth Elektronik eiSos GmbH & Co. KG contain statements regarding general suitability for certain application areas. These statements about suitability are based on our knowledge and experience of typical requirements concerning the areas, serve as general guidance and cannot be estimated as binding statements about the suitability for a customer application. The responsibility for the applicability and use in a particular customer design is always solely within the authority of the customer. Due to this fact it is up to the customer to evaluate, where appropriate to investigate and decide whether the device with the specific product characteristics described in the product specification is valid and suitable for the respective customer application or not.

### 2. Customer Responsibility related to Specific, in particular Safety-Relevant Applications

It has to be clearly pointed out that the possibility of a malfunction of electronic components or failure before the end of the usual lifetime cannot be completely eliminated in the current state of the art, even if the products are operated within the range of the specifications. In certain customer applications requiring a very high level of safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health it must be ensured by most advanced technological aid of suitable design of the customer application that no injury or damage is caused to third parties in the event of malfunction or failure of an electronic component. Therefore, customer is cautioned to verify that data sheets are current before placing orders. The current data sheets can be downloaded at www.we-online.com.

#### 3. Best Care and Attention

Any product-specific notes, cautions and warnings must be strictly observed. Any disregard will result in the loss of warranty.

### 4. Customer Support for Product Specifications

Some products within the product range may contain substances which are subject to restrictions in certain jurisdictions in order to serve specific technical requirements. Necessary information is available on request. In this case the field sales engineer or the internal sales person in charge should be contacted who will be happy to support in this matter.

### 5. Product R&D

Due to constant product improvement product specifications may change from time to time. As a standard reporting procedure of the Product Change Notification (PCN) according to the JEDEC-Standard inform about minor and major changes. In case of further queries regarding the PCN, the field sales engineer or the internal sales person in charge should be contacted. The basic responsibility of the customer as per Section 1 and 2 remains unaffected.

### 6. Product Life Cycle

Due to technical progress and economical evaluation we also reserve the right to discontinue production and delivery of products. As a standard reporting procedure of the Product Termination Notification (PTN) according to the JEDEC-Standard we will inform at an early stage about inevitable product discontinuance. According to this we cannot guarantee that all products within our product range will always be available. Therefore it needs to be verified with the field sales engineer or the internal sales person in charge about the current product availability expectancy before or when the product for application design-in disposal is considered. The approach named above does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

### 7. Property Rights

All the rights for contractual products produced by Würth Elektronik eiSos GmbH & Co. KG on the basis of ideas, development contracts as well as models or templates that are subject to copyright, patent or commercial protection supplied to the customer will remain with Würth Elektronik eiSos GmbH & Co. KG does not warrant or represent that any license, either expressed or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, application, or process in which Würth Elektronik eiSos GmbH & Co. KG components or services are used.

### 8. General Terms and Conditions

Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms and Conditions of Würth Elektronik eiSos Group", last version available at www.we-online.com.

